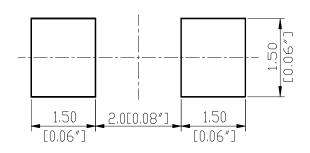


3.2 x 1.6 x 1.1 mm Green SMD LED

### **PACKAGE OUTLINES**

# 3.20 [0.13"] LED Chip 2.00 [0.08"] 2.00 [0.08"] 1 10 [0.08"]

### **RECOMMEND PAD LAYOUT**



ITEM	MATERIALS
Resin (mold)	Ероху
Lens color	Color Diff
Dice	GaP/GaP
Emitted color	Green

### NOTES:

- 1. All dimensions are in millimeters (inches);
- 2. Tolerances are  $\pm 0.1$ mm (0.004inch) unless otherwise noted.



3.2 x 1.6 x 1.1 mm Green SMD LED

### **ABSOLUTE MAXIMUM RATINGS**

(Ta=25°C)

Parameter	Symbol	Value	Unit
Forward current	If	30	mA
Reverse voltage	Vr	5	V
Power dissipation	Pd	75	mW
Operating temperature range	Тор	-40~+85	°C
Storage temperature range	Tstg	-40~+85	°C
Peak pulsing current (1/8 duty f= 1kHz)	lfp	125	mA

### **OPTICAL-ELECTRICAL CHARACTERISTICS**

(Ta=25°C)

Parameter	Symbol	ymbol Test Condition		Тур	Max	Unit
Wavelength at peak emission	λ peak	λ peak I <sub>F</sub> = 20mA		565		nm
Spectral half bandwidth	Δλ	Δλ I <sub>F</sub> = 20mA		27		nm
Dominant wavelength	λ dom	I <sub>F</sub> = 20mA	565	570	576	nm
Forward Voltage	Vf	I <sub>F</sub> = 20mA	1.7	2.2	2.5	V
Luminous intensity	lv	I <sub>F</sub> = 20mA	2	7	16	mcd
Viewing angle at 50% lv	20 ½	I <sub>F</sub> = 10mA		140		Deg
Reverse current	lr	Vr=5V			10	μA



3.2 x 1.6 x 1.1 mm Green SMD LED

Forward Voltage Rank Combination (IF=20mA)							
Rank Code		Min.			Max.	Unit	
		1.7			2.5	V	
Luminous Intensity Rank Combination (IF=20mA)							
Rank Code		Min.			Max.	Unit	
6		2.0			3.2		
7		3.2			5.0		
8		5.0			8.0	mcd	
9		8.0			12.5		
А		12.5			16		
Dominant wavelength Rank Combination (IF=20mA)							
Rank Code		Min			Max	Unit	
h		565			568		
i		568 572			572	nm	
j					576		
Group Name on Label (Example DATA: □8i 20)							
DATA: □8i 20		Vf(V)	lv (mcd	)	λ d (nm)	Test Condition	
□→8→i→20	)	1.7~2.5	5.0~8.0		568~572	IF=20mA	

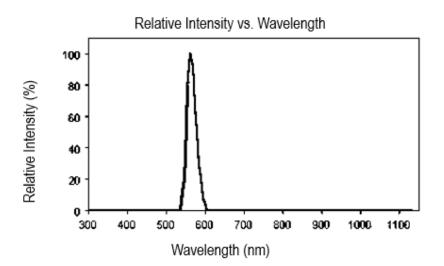
### \* NOTE:

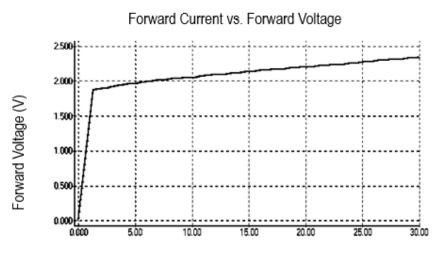
- 1. The tolerance of luminous intensity (Iv) is ±15%.
- 2. The tolerance of dominant wavelength is ±1nm.
- 3. This specification is preliminary.



3.2 x 1.6 x 1.1 mm Green SMD LED

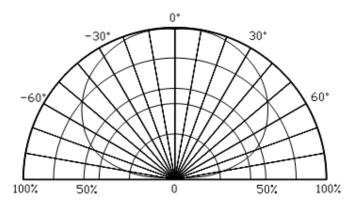
### **OPTICAL CHARACTERISTIC CURVES**





Forward Current (mA)

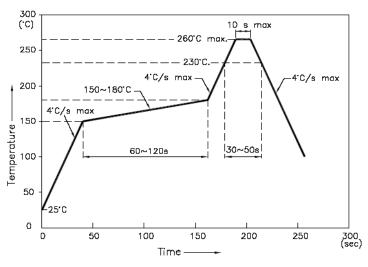
Directive Characteristics





3.2 x 1.6 x 1.1 mm Green SMD LED

### **REFLOW PROFILE**



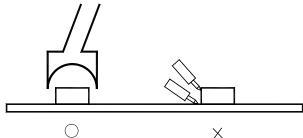
### NOTES:

- 1. We recommend the reflow temperature 245°C (±5°C). The maximum soldering temperature should be limited to 260°C.
- 2. Do not cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.
  - Soldering iron

Basic spec is  $\leq$  5sec when 260°C. If temperature is higher, time should be shorter (+10°C  $\rightarrow$  -1sec). Power dissipation of iron should be smaller than 20W, and temperatures should be controllable .Surface temperature of the device should be under 230°C.

### Rework

- 1. Customer must finish rework within 5 sec under 260°C.
- 2. The head of iron cannot touch copper foil
- 3. Twin-head type is preferred.



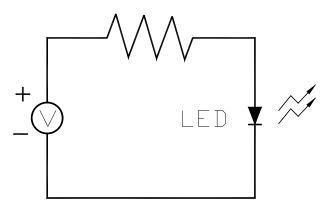
 Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow, solder etc.



3.2 x 1.6 x 1.1 mm Green SMD LED

### TEST CIRCUIT AND HANDLING PRECAUTIONS

### Test circuit



### Handling precautions

### 1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage will cause big current change (Burn out will happen).

### 2. Shelf life in sealed bag

12 month at  $5^{\circ}$ C $\sim$ 30 $^{\circ}$ C and <60 $^{\circ}$ K.H;

### 3. After the package is Opened

It is recommended to baking before the first use:

Baking condition:

- a.  $60\pm3^{\circ}$ C x ( $36\sim48$ hrs) and <5%RH, taped reel type;
- b. 110±3°C x (8~16hr), bulk type;

The products should be used within a week or they should be keeping to be stored at ≦20 R.H. with zip-lock sealed.

It is recommended to baking before soldering when the pack is unsealed after 72hrs; Baking condition as 3.1 baking condition.



3.2 x 1.6 x 1.1 mm Green SMD LED

### **TEST ITEMS AND RESULTS OF RELIABILITY**

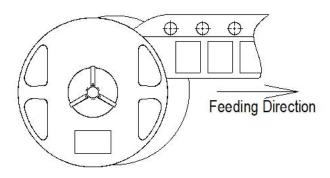
Туре	Test Item	Test Conditions	Note	Number of Damaged
	Temperature Cycle	-20°C 30min ↑↓ 80°C 30min	100 cycle	0/22
	Thermal Shock	-20°C 15min ↑↓ 80°C 15min	100 cycle	0/22
mental ence	High Humidity Heat Cycle	30°C⇔ 65°C 90%RH 24hrs/1cycle	10 cycle	0/22
Environmental Sequence	High Temperature Storage	T <sub>a</sub> =80°C	1000 hrs	0/22
	Humidity Heat Storage	T <sub>a</sub> =60°C RH=90%	1000 hrs	0/22
	Low Temperature Storage	T <sub>a</sub> =-30°C	1000 hrs	0/22
Operation Sequence	Life Test	T <sub>a</sub> =25°C I <sub>F</sub> =20mA	1000 hrs	0/22
	High Humidity Heat Life Test	60°C RH=90% I <sub>F</sub> =10mA	500 hrs	0/22
	Low Temperature Life Test	T <sub>a</sub> =-20°C I <sub>F</sub> =20mA	1000 hrs	0/22



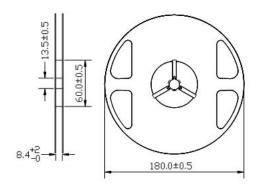
3.2 x 1.6 x 1.1 mm Green SMD LED

### PACKAGING SPECIFICATION

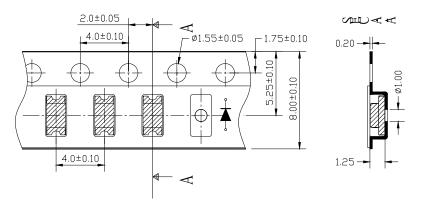
Feeding Direction



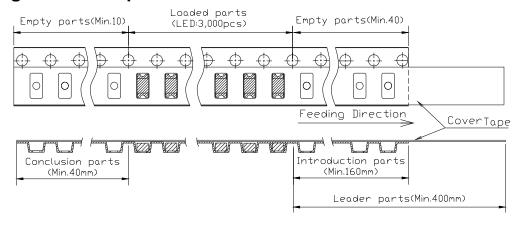
• Dimensions of Reel (Unit: mm)



• Dimensions of Tape (Unit: mm)



Arrangement of Tape



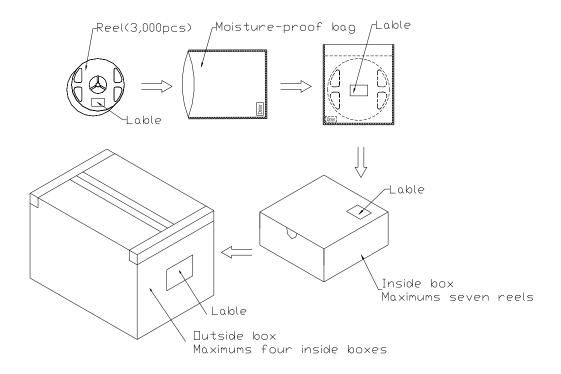
### Notes:

- 1. Empty component pockets are sealed with top cover tape;
- 2. The maximum number of missing lamps is two;
- 3. The cathode is oriented towards the tape sprocket hole.
- 4. 3,000 pcs/Reel



3.2 x 1.6 x 1.1 mm Green SMD LED

### PACKAGING SPECIFICATIONS



### **Notes**

Reeled products (numbers of products are 3,000pcs) packed in a seal off moisture-proof bag along with a desiccant one by one, Seven moisture-proof bag of maximums (total maximum number of products are 21,000pcs) packed in an inside box (size: about 238mm x about 194mm x about 102mm) and four inside boxes of maximums are put in the outside box (size: about 410mm x about 254mm x about 229mm) Together with buffer material, and it is packed. (Part No., Lot No., quantity should appear on the label on the moisture-proof bag, part No. And quantity should appear on the label on the cardboard box.) The number of the loading steps of outside box (cardboard box) has it to three steps.